IGBT

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss.

Features

- Low Saturation Voltage using Trench with Field Stop Technology
- Low Switching Loss Reduces System Power Dissipation
- Soft Fast Reverse Recovery Diode
- Optimized for High Speed Switching
- 5 µs Short–Circuit Capability
- These are Pb-Free Devices

Typical Applications

- Solar Inverters
- Uninterruptable Power Supply (UPS)

ABSOLUTE MAXIMUM RATINGS

Symbol	Value	Unit
V _{CES}	600	V
lc	80 40	A
I _{CM}	160	A
IF	80 40	A
I _{FM}	160	A
t _{SC}	5	μs
V _{GE}	±20 ±30	V
P _D	257 102	W
TJ	–55 to +150	°C
T _{stg}	–55 to +150	°C
T _{SLD}	260	°C
	I _C I _C I _F I _{FM} t _{SC} V _{GE} P _D T _J T _{stg}	$\begin{array}{c c} V_{CES} & 600 \\ \hline V_{CES} & 600 \\ \hline I_C & 80 \\ 40 \\ \hline I_{CM} & 160 \\ \hline I_{FM} & 160 \\ \hline I_{FM} & 160 \\ \hline I_{FM} & 160 \\ \hline t_{SC} & 5 \\ \hline V_{GE} & \frac{\pm 20}{\pm 30} \\ \hline V_{GE} & \frac{\pm 20}{\pm 30} \\ \hline T_{J} & -55 \text{ to } +150 \\ \hline T_{stg} & -55 \text{ to } +150 \end{array}$

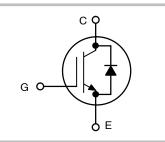
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

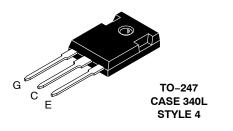


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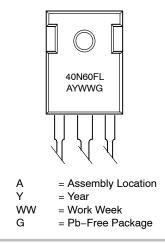
http://onsemi.com

40 A, 600 V V_{CEsat} = 1.85 V





MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
NGTB40N60FLWG	TO–247 (Pb–Free)	30 Units / Rail

THERMAL CHARACTERISTICS

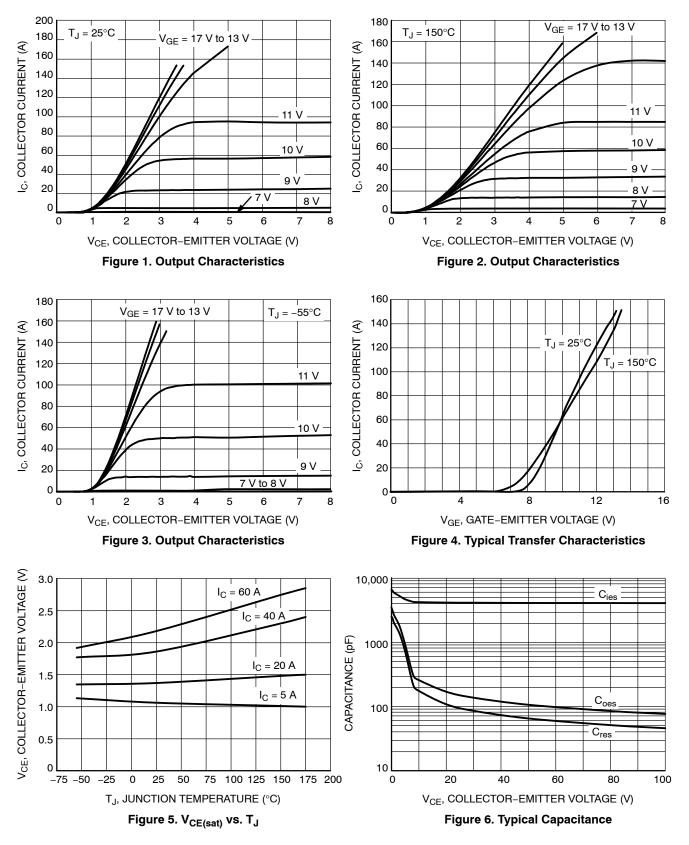
Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ ext{ heta}JC}$	0.470	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ ext{ heta}JC}$	1.06	°C/W
Thermal resistance junction-to-ambient	$R_{\theta JA}$	40	°C/W

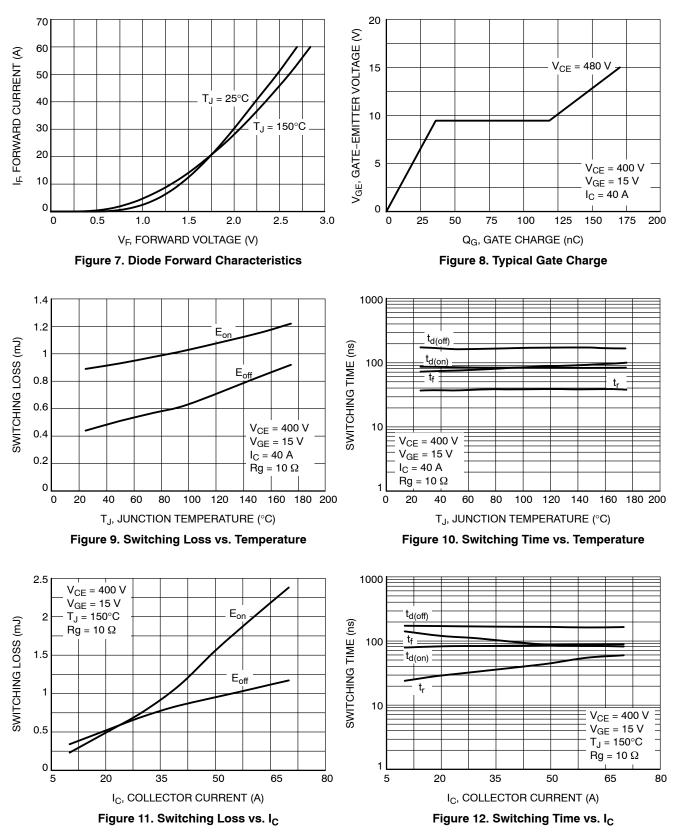
ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise specified)

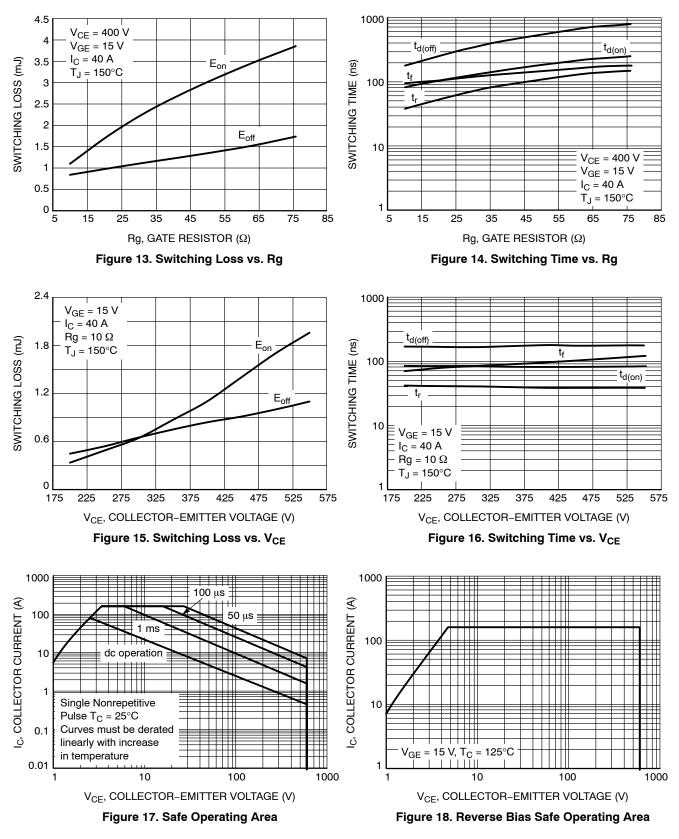
Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC	•	-	-	-	-	-
Collector-emitter breakdown voltage, gate-emitter short-circuited	V_{GE} = 0 V, I _C = 500 µA	V _{(BR)CES}	600	-	_	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 40 A V_{GE} = 15 V, I _C = 40 A, T _J = 150°C	V _{CEsat}	1.6 _	1.85 2.3	2.1 -	V
Gate-emitter threshold voltage	V_{GE} = V_{CE} , I_C = 200 μ A	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	$V_{GE} = 0 V$, $V_{CE} = 600 V$ $V_{GE} = 0 V$, $V_{CE} = 600 V$, $T_{J} = 150^{\circ}C$	I _{CES}	-		0.2 2	mA
Gate leakage current, collector-emitter short-circuited	V_{GE} = 20 V , V_{CE} = 0 V	I _{GES}	-	-	100	nA
DYNAMIC CHARACTERISTIC	•					
Input capacitance		C _{ies}	-	4200	_	pF
Output capacitance	V _{CE} = 20 V, V _{GE} = 0 V, f = 1 MHz	C _{oes}	-	170	_	
Reverse transfer capacitance	1	C _{res}	-	110	_	
Gate charge total		Qg	-	171	_	nC
Gate to emitter charge	V _{CE} = 480 V, I _C = 40 A, V _{GE} = 15 V	Q _{ge}	-	36	_	
Gate to collector charge	1	Q _{gc}	-	83	-	
SWITCHING CHARACTERISTIC, INDUC	TIVE LOAD					
Turn-on delay time		t _{d(on)}	-	85	_	ns
Rise time	1	t _r	-	37	_	
Turn-off delay time	T _J = 25°C	t _{d(off)}	-	174	-	
Fall time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 40 \text{ A}$ $R_{g} = 10 \Omega$	t _f	-	73	-	
Turn-on switching loss	$V_{GE} = 0 V/15 V$	E _{on}	-	0.89	-	mJ
Turn-off switching loss	1	E _{off}	-	0.44	-	
Total switching loss]	E _{ts}	-	1.33	-	
Turn-on delay time		t _{d(on)}	-	82	-	ns
Rise time]	t _r	-	38	-	
Turn-off delay time	T _J = 150°C	t _{d(off)}	-	179	-	
Fall time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 40 \text{ A}$ $R_{a} = 10 \Omega$	t _f	-	95	-	
Turn-on switching loss	$R_g = 10 \Omega$ $V_{GE} = 0 V/ 15 V$	E _{on}	-	1.10	-	mJ
Turn-off switching loss		E _{off}	-	0.84	-	
Total switching loss	1	E _{ts}	-	1.94	-	1

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
DIODE CHARACTERISTIC						
Forward voltage	V_{GE} = 0 V, I _F = 40 A V_{GE} = 0 V, I _F = 40 A, T _J = 150°C	V _F	1.55 -	2.2 2.3	2.60 -	V
Reverse recovery time	T.I = 25°C	t _{rr}	-	77	-	ns
Reverse recovery charge	I _F = 40 Å, V _R = 200 V	Q _{rr}	-	0.35	-	μC
Reverse recovery current	di _F /dt = 200 A/µs	I _{rrm}	-	7	-	Α







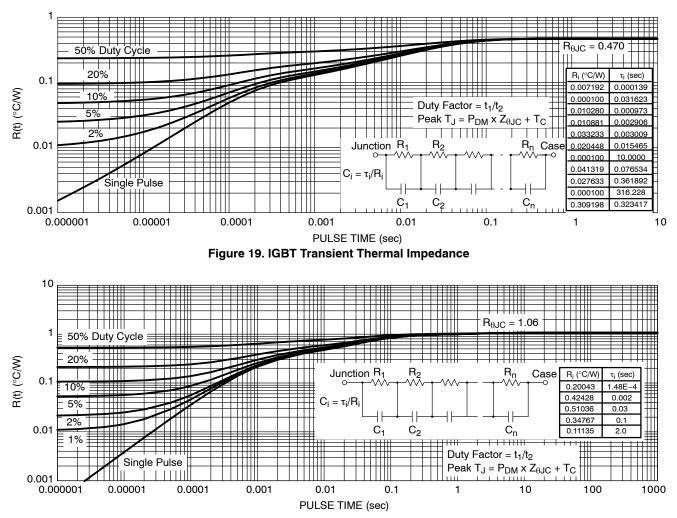


Figure 20. Diode Transient Thermal Impedance

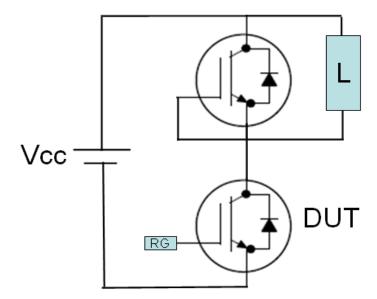


Figure 21. Test Circuit for Switching Characteristics

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

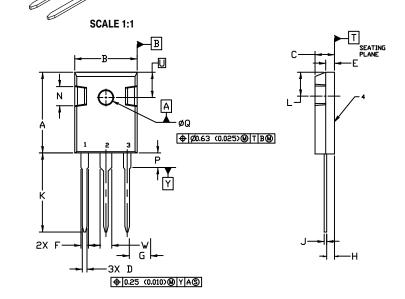
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DATE 06 OCT 2021

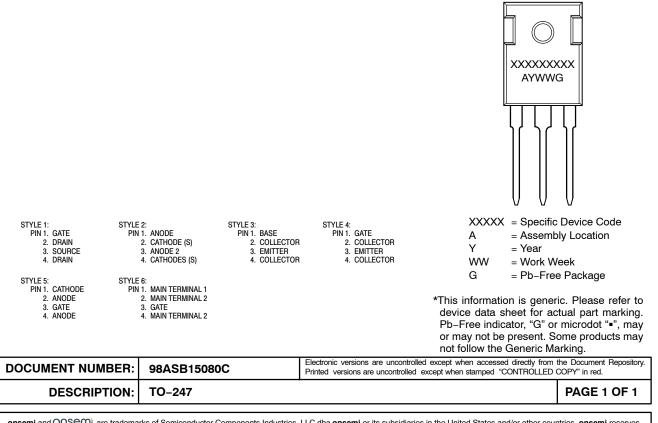


- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER



	MILLIMETERS		INC	HES
DIM	MIN.	MAX.	MIN.	MAX.
Α	20.32	21.08	0.800	0.830
В	15.75	16.26	0.620	0.640
С	4.70	5.30	0.185	0.209
D	1.00	1.40	0.040	0.055
E	1.90	2.60	0.075	0.102
F	1.65	2.13	0.065	0.084
G	5.45	BSC	0.215 BSC	
Н	1.50	2.49	0.059	0.098
J	0.40	0.80	0.016	0.031
к	19.81	20.83	0.780	0.820
L	5.40	6.20	0.212	0.244
N	4.32	5.49	0.170	0.216
Р		4.50		0.177
Q	3.55	3.65	0.140	0.144
U	6.15	BSC	0.242	BSC
V	2.87	3.12	0.113	0.123

GENERIC **MARKING DIAGRAM***



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